

# LumiCal DAQ concept & other detectors data rates

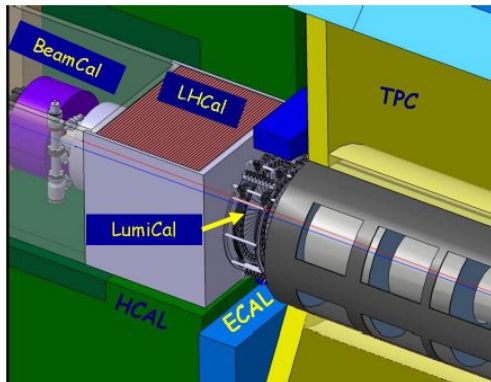
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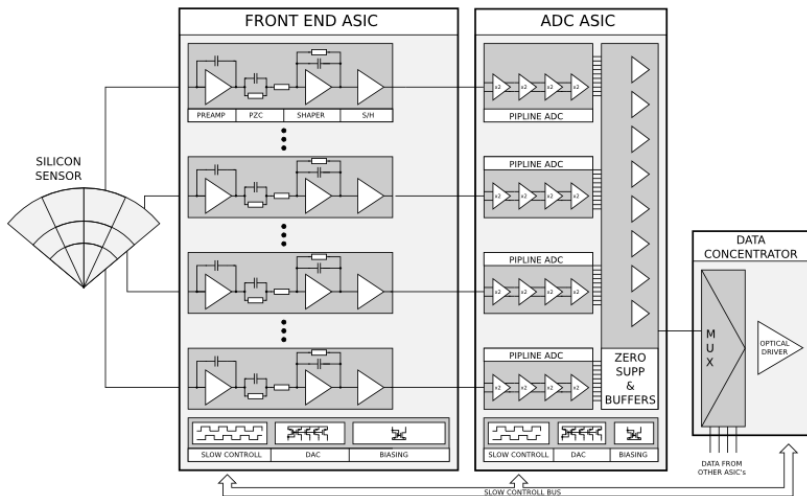
FCAL Meeting, 12-13 April 2010, IFJ, Cracow

# Outline

- 1 LumiCal DAQ  
concept and data  
rates
- 2 Other detectors data  
rates
  - BeamCal
  - Pair-Monitor in  
front of BeamCal
  - LHCal
- 3 Summary

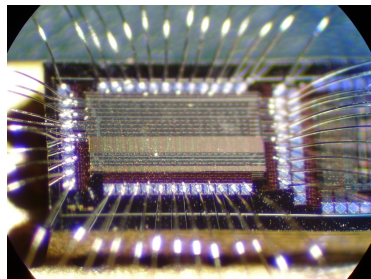


# LumiCal readout



# Front-end electronics status

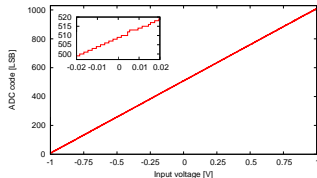
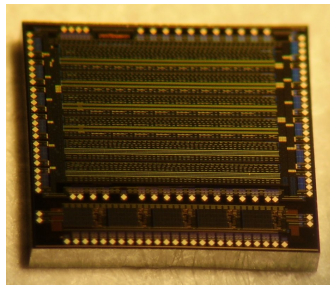
- architecture: charge amplifier with 1st order shaper
- prototypes fabricated, tested and ready for beam-test
- present technology  
AMS 0.35  $\mu\text{m}$
- Power: 8.9 mW/channel



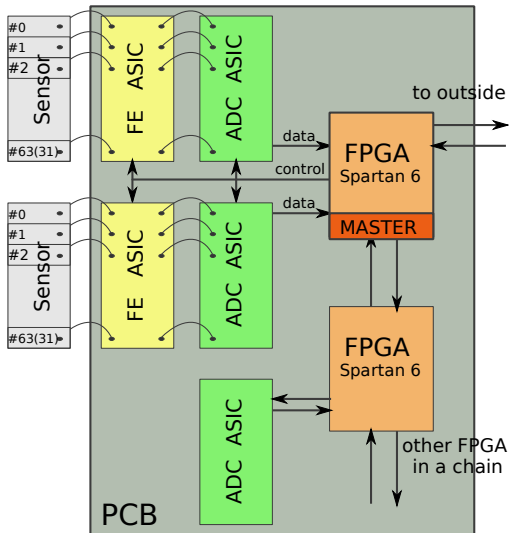
Mode	Gain [mV/fC]	Noise@50pF [fC]	Linearity [pC]	Rate [MHz]	Crosstalk [%]
Physics	0.107	0.62	10	3	$\approx 1$
Calibration	$\approx 20$	0.28	0.035	3	$\approx 0.1$

# 10-bit pipeline ADC prototypes

- architecture: 10 bit pipeline
- 1st prototype: only 8 stages
- 2nd prototype (photo): 9 stages + S/H + digital correction + clock and power switching
- No reference voltages yet - applied externally
- Both prototypes tested and fully functional
- 3rd prototype – multichannel (8) ADC with serial output should be in Cracow this or next week

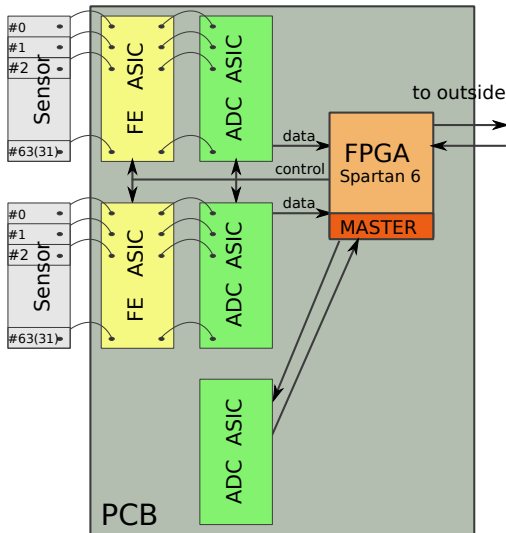


# LumiCal Readout (**option 1**) (AGH & IFJ Cracow)



- one ADC for each FE channel
- one FE & ADC ASICs per 32 (or 64) channels
- 4 or 8 ADC ASICs per 1 FPGA
- one master FPGA per half-layer (or 2 for redundancy)
- FPGA serves as data concentrator and memory

# LumiCal Readout (option 2)



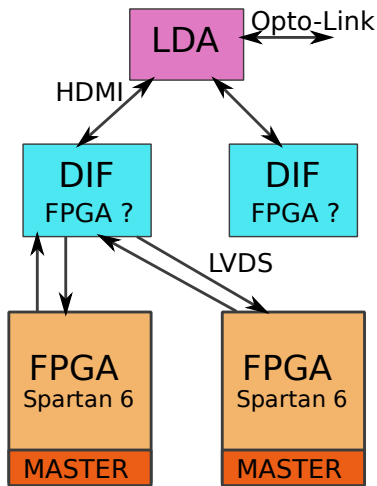
- ADC ASIC with zero suppression and small memory
- one FE & ADC ASICs per 32 (or 64) channels
- one FPGAs per half-layer (or 2 for redundancy)
- FPGA serves as data concentrator and 2nd level memory

# FPGA possible candidate

- Spartan-6 FPGA
- technology 45 nm should be partially radiation hard
- for example XC6SLX45T
  - size:  $15 \times 15$  or  $19 \times 19$  mm
  - memory 2MB
  - user I/O up to 296
  - 4 high speed transceivers from 614 Mbit/s to 3.125 Gbit/s

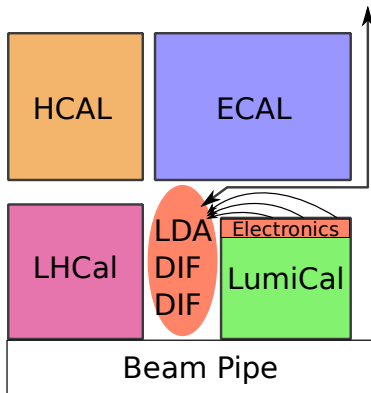


# Second Level of LumiCal Readout



- data are sent out in the gap between or during the train **(to be decided)**
- master FPGAs are connected via LVDS link to DIF
- one master FPGAs for one half-layer results in 60 LVDS links (or 120 with redundancy)
- one LDA is enough in slow scenario (readout in the gap) or  $\sim 5$  for fast readout

# Where to place the DAQ components?

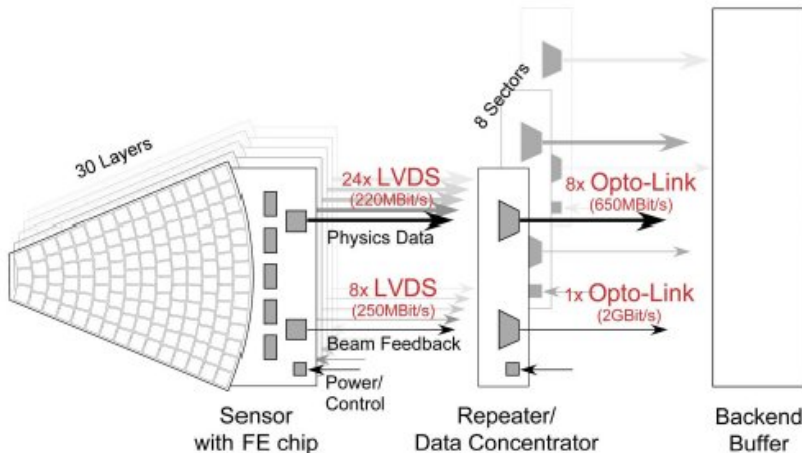


- DAQ components may be placed between LumiCal and LHCaI. Is there enough space?
- what about radiation resistance of DIF and LDA? Can they tolerate radiation loads in this location?

# Data volume and rate

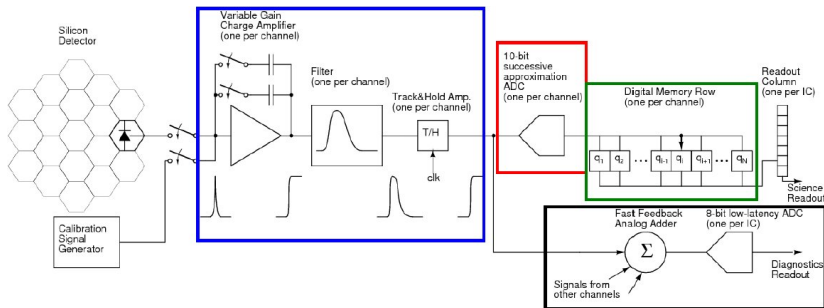
- average data volume
  - average number of hits in a single channel is around 10 per train but the standard deviation is also 10
  - $10 \text{ hit/train} * (10^5 \text{ channels}) \approx 1 \text{ M hit/train}$
  - $1 \text{ M} * (10 \text{ ADC bits} + 20 \text{ address bits}) \approx 4 \text{ MB/train}$
  - occupancy per train:  $10^5 \text{ channels} / 1 \text{ M hit} \approx 1\%$  (70% in LOI)
- data readout scenarios
  - data are sent in the gap between trains:  $4 \text{ MB} / 200 \text{ ms} = 160 \text{ Mbit/s}$
  - data are sent during train:  $4 \text{ MB} / 1 \text{ ms} = 16 \text{ Gbit/s}$

# BeamCal readout (DESY Zeuthen)



- similar to LumiCal concept
- no DIFs & LDAs in the moment

# BeamCal readout ASIC (SLAC)



- technology TSMC 0.18  $\mu\text{m}$
- 32 channels
- memory: 2820 words (10 bits + parity) per channel
- analog addition of 32 channels for fast feedback

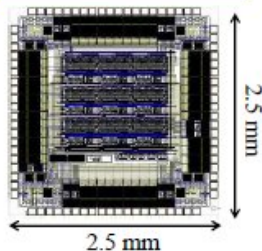
# BeamCal data volume and rate

- data volume
  - 8 sectors/layer and 30 layers
  - total 38400 channels with occupancy  $\sim 100\%$
  - $38400 * 10 \text{ bit} * 2820 \text{ bx} = 130 \text{ MB per train}$
- data readout
  - data are sent in the gap between trains:  $130 \text{ MB}/200 \text{ ms} = 5 \text{ Gbit/s}$
  - so we need at least 2 LDAs ( $2 * 3 \text{ Gbit/s}$ ) + 1 (redundancy)
- fast feedback – data are read out after each bx
  - 2 layers only \*  $1280 \text{ channels}/32 * 8 \text{ bit/bx} = 80 \text{ B/bx}$
  - the data rate is  $1.6 \text{ Gbit/s}$

# Pair Monitor (Tohoku Univ.)

- placed at the front of BeamCal
- 1st prototype was done in TSMC  $0.18\ \mu\text{m}$
- 2nd prototype fabricated in FD-SOI CMOS  $0.2\ \mu\text{m}$
- radiation tests are running
- $200\,000\ \text{pixels} \times 8\ \text{bits} \times 16 = 3.2\ \text{MB}$  per train
- data are sent in the gap between trains:  $\sim 128\ \text{Mbit/s}$

Layout of readout ASIC



# LHCal

- necessary for hermeticity of hadronic events. It will cover the square hole in HCAL.
- Calorimeter in Si/W technology with 40 tungsten layers (10 mm thick), at  $\sim 4$  interaction lengths
- in comparison to BeamCal and LumiCal it gives a relatively small amount of additional data
- but in the moment no one is working on it!



# Summary

- forward detectors electronics status
  - LumiCal: front-end and single channel ADC ASICs are ready, multichannel ADC will be in Cracow in the next week
  - BeamCal: readout chip is ready (?)
  - Pair Monitor: readout chip is during radiation tests
- data volumes and rates are known
  - in LumiCal: 4 MB/train and 160 Mbit/s or 16 Gbit/s
  - in BeamCal: 130 MB/train and 5 Gbit/s
  - BeamCal fast feedback: 80 B/bx and 1.6 Gbit/s
  - in Pair Monitor: 3.2 MB/train and 128 Mbit/s
- data readout and DAQ are in the conception phase
- common DAQ scheme with DIFs and LDAs can be use
- important questions concerning available space and radiation tolerance of DIF & LDA
- how to build DIF?